

09-30-1999



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To the **Honorable Commissioner of Patents and Trademarks**. Please record the attached original documents or copies thereof.

## 1. Name of Conveying Party(ies):

Lung-hsin CHEN

☐ Additional names of conveying parties attached.

## 3. Nature of Conveyance:

- ☒ Assignment                      ☐ Merger  
☐ Security Agreement           ☐ Change of Name  
☐ Other:

Execution Date: 8/1/99

## 4. (A) Patent Application Number(s):

## 2. Name and Address of Receiving Party(ies):

Name: **VIKING TECH CORPORATION**

Internal Address:

Street Address: No. 8 Innovation Road 1, Science  
Based Industrial Park

City, State, Zip: Hsinchu, TAIWAN, R.O.C.

☐ Additional name(s) and address(es) attached.

## 4. (B) Patent Number(s):

09/399365

If this document is being filed together with a new  
application, the execution date of the application is: 8/1/99☐ Additional Numbers Attached.5. Name and Address of Party to whom Correspondence Concerning this  
Document Should be Mailed:Name: **Eugene Mar**Address: **Bacon & Thomas**  
625 Slaters Lane  
Alexandria, VA 22314Total Number of Applications and  
Patents Involved:

1

7. Total Fee:  
(37 CFR 3.41)

\$40.00

- ☒ Enclosed  
☐ Authorized to be charged to deposit account

8. Deposit Account Number: 02-0200

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## 9. Statement and Signature:

**To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is  
a true copy of the original document.**

Eugene Mar

Name of Person Signing

Signature

September 20, 1999

Date

Total number of pages including cover sheet, attachments and document: 2

# ASSIGNMENT

WHEREAS, I (we), Lung-hsin CHEN

whose post office address(es) appears(s) below, hereinafter referred to as ASSIGNOR, is(are) the owner of certain new and useful improvements in

## PACKAGING METHOD OF THIN FILM PASSIVE COMPONENTS ON SILICON CHIP

(hereinafter referred to as the INVENTION) for which an application for United States Letters Patent was

☒ executed on even data herewith

☐ executed on:

☐ filed on: Serial No.:

☐ established by PCT International Patent Application No.:  
designating the United States of America

filed:

WHEREAS, VIKING TECH CORPORATION

whose post office address is No. 8, Innovation Road 1, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in and to the same in the United States;

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I(we), ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the UNITED States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application.

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the INVENTION that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behoof; and for the use and behoof of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

ASSIGNOR authorizes any member of the firm of *Bacon & Thomas* to insert or complete any information in this document needed to effect its recordal in the U.S. Patent and Trademark Office.

Assignor Name Lung-hsin CHEN	Address No. 8, Innovation Road 1, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.
Where Signed Taiwan, R.O.C.	
Date 1999. 8. 1	Signature <i>Lung-Hsin Chen</i>
Witness (optional)	Witness (optional)
Print/Type Name	Print/Type Name
Signature	Signature

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